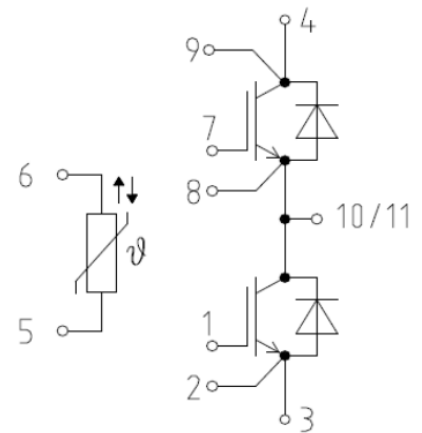


C5 series package: 1200V 900A IGBT module

[Datasheet](#)



Equivalent
Circuit Schematic

Features:

- Trenchgate Gen.7 IGBT technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High RBSOA capability
- Low static losses: $V_{CE(sat)} = 1,55V@25^{\circ}C$
- Low dynamic losses

Options:

- Pre-applied TIM (option +M01)
- Adoption for parallel connection (V_f selection)

Typical Applications:

- Motor Drives
- Solar Applications
- UPS Systems
- Energy Storage

**IGBT, Inverter / IGBT
Maximum Rated Values**

| | | | | |
|-----------------------------------|---|------------|----------|---|
| Collector-emitter Voltage | $T_{vj} = 25^{\circ}\text{C}$ | V_{CES} | 1200 | V |
| Implemented Collector Current | | I_{Cnom} | 900 | A |
| Continuous DC Collector Current | $T_C = 45^{\circ}\text{C}, T_{vj\ max} = 175^{\circ}\text{C}$ | I_C | 875 | A |
| Repetitive Peak Collector Current | $t_p = 1\text{ms}$ | I_{CRM} | 1800 | A |
| Gate-emitter Peak Voltage | | V_{GES} | ± 20 | V |

Characteristic Values
min. typ. max.

| | | | | | | | |
|--|---|---|-------------|-----|------------------------------|-----|---------------|
| Collector-emitter Saturation Voltage ¹⁾ | $I_C = 900\text{A}, V_{GE} = 15\text{V}$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | V_{CEsat} | - | 1.55 1.80 1.83 1.86 | - | V |
| Gate Threshold Voltage | $V_{CE} = V_{GE}, I_C = 18\text{mA}, T_{vj} = 25^{\circ}\text{C}$ | | V_{GEth} | 5.0 | 6.0 | 7.0 | V |
| Gate Charge | $V_{GE} = -15\text{V}/15\text{V}, V_{CE} = 600\text{V}$ | | Q_G | - | 11.2 | - | μC |
| Internal Gate Resistor | $T_{vj} = 25^{\circ}\text{C}$ | | R_{Gint} | - | 0.2 | - | Ω |
| Input Capacitance | $f = 100\text{kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$ | | C_{ies} | - | 199 | - | nF |
| Reverse Transfer Capacitance | $f = 100\text{kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$ | | C_{res} | - | 0.57 | - | nF |
| Collector-emitter Cutoff Current | $V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$ | | I_{CES} | - | - | 0.1 | mA |
| Gate-emitter Leakage Current | $V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$ | | I_{GES} | - | - | 500 | nA |
| Turn-on Delay Time, Inductive Load | $I_C = 900\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = -8\text{V}/15\text{V}$ $R_{GON} = 1\Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | t_{don} | - | 197 262 264 267 | - | ns |
| Rise Time, Inductive Load | $I_C = 900\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = -8\text{V}/15\text{V}$ $R_{GON} = 1\Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | t_r | - | 93 107 110 114 | - | ns |
| Turn-off Delay Time, Inductive Load | $I_C = 900\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = -8\text{V}/15\text{V}$ $R_{Goff} = 1\Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | t_{doff} | - | 560 582 595 600 | - | ns |
| Fall Time, Inductive Load | $I_C = 900\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = -8\text{V}/15\text{V}$ $R_{Goff} = 1\Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | t_f | - | 99 150 172 198 | - | ns |
| Turn-on Energy Loss per Pulse | $I_C = 900\text{A}, V_{CE} = 600\text{V}, L_{\sigma} = 30\text{nH}$ $V_{GE} = -8\text{V}/15\text{V}, R_{GON} = 1\Omega$ $di/dt = 6131 (T_{vj} = 175^{\circ}\text{C})$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | E_{on} | - | 97 129 138 148 | - | mJ |
| Turn-off energy Loss per Pulse | $I_C = 900\text{A}, V_{CE} = 600\text{V}, L_{\sigma} = 30\text{nH}$ $V_{GE} = -8\text{V}/15\text{V}, R_{GON} = 1\Omega$ $du/dt = 4762 (T_{vj} = 175^{\circ}\text{C})$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | E_{off} | - | 75 100 106 112 | - | mJ |
| SC Data | $V_{GE} = -8\text{V}/15\text{V}$ $V_{CC} = 600\text{V}$ | $t_p \leq 8\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ $t_p \leq 6\mu\text{s}, T_{vj} = 175^{\circ}\text{C}$ | I_{sc} | - | 3200 3100 | - | A |

| | | | | | | |
|--|---|--------------------|-----|-------|-----|-----|
| Thermal Resistance, Junction to Case | Per IGBT | R _{thJC} | - | 0.028 | - | K/W |
| Thermal Resistance, Case to Heatsink | Per IGBT, λ _{grease} = 1W(m•K) | R _{thCH} | - | 0.035 | - | K/W |
| Temperature under Switching Conditions | | T _{vj op} | -40 | | 175 | °C |

Diode, Inverter Maximum Rated Values

| | | | | | | |
|---------------------------------|------------------------|-------------------|--|------|--|---|
| Repetitive Peak Reverse Voltage | T _{vj} = 25°C | V _{RRM} | | 1200 | | V |
| Continuous DC Forward Current | | I _{Fnom} | | 900 | | A |
| Repetitive Peak Forward Current | t _p = 1ms | I _{FRM} | | 1800 | | A |

Characteristic Values

| | | | min. typ. max. | | | | |
|--|--|---|----------------------|-----|------------------------------|-----|-----|
| Forward Voltage ¹⁾ | I _F = 900A, V _{GE} = 0V | T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 150°C T _{vj} = 175°C | V _F | - | 1.83 2.10 2.17 2.25 | - | V |
| Peak Reverse Recovery Current | I _F = 900A, V _R = 600V -di _F /dt = 5556A/us (T _{vj} = 175°C) V _{GE} = -8V | T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C | I _{RM} | - | 420 444 476 | - | A |
| Recovery Charge | I _F = 900A, V _R = 600V -di _F /dt = 5556A/us (T _{vj} = 175°C) V _{GE} = -8V | T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C | Q _R | - | 34 55 71 | - | μC |
| Reverse Recovery Energy | I _F = 900A, V _R = 600V -di _F /dt = 5556A/us (T _{vj} = 175°C) V _{GE} = -8V | T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C | E _{rec} | - | 7 25 29 | - | mJ |
| Thermal Resistance, Junction to Case | Per FRD | | R _{thJC} | - | 0.063 | - | K/W |
| Thermal Resistance, Case to Heatsink | Per FRD, λ _{grease} = 1W(m•K) | | R _{thCH} | - | 0.039 | - | K/W |
| Temperature under Switching Conditions | | | T _{vj op} | -40 | - | 175 | °C |

NTC-Thermistor / NTC Maximum Rated Values

| | | | min. typ. max. | | | | |
|---------------------------|---|--|----------------------|------|------|-----|----|
| Rated Resistance | T _{NTC} = 25°C | | R ₂₅ | - | 5 | - | KΩ |
| Deviation of R100 R100 | T _{NTC} = 100°C, R ₁₀₀ = 465Ω | | ΔR/R | -7.3 | - | 7.3 | % |
| Power Dissipation | T _{NTC} = 25°C | | P ₂₅ | - | - | 10 | mW |
| B-Value B | R ₂ = R ₂₅ exp[B _{25/50} (1/T ₂ -1/(298.15K))] | | B _{25/50} | - | 3380 | - | K |
| | R ₂ = R ₂₅ exp[B _{25/80} (1/T ₂ -1/(298.15K))] | | B _{25/80} | - | 3470 | - | K |
| | R ₂ = R ₂₅ exp[B _{25/100} (1/T ₂ -1/(298.15K))] | | B _{25/100} | - | 3520 | - | K |

Module

| | | | | |
|------------------------------|---------------------------|-------|-------------------|----|
| Isolation Test Voltage | RMS, f=50Hz, t=1min | ViSOL | 3.0 | kV |
| Material of Module Baseplate | | | Cu | |
| Internal Isolation | | | ZTA | |
| Creepage Distance | Terminal to heatsink, min | | 15.0 | mm |
| | Terminal to terminal, min | | 13.0 | |
| Clearance | Terminal to heatsink, min | | 12.5 | mm |
| | Terminal to terminal, min | | 10.0 | |
| Comparative Tracking Index | | CTI | 200 ²⁾ | |

min. typ. max.

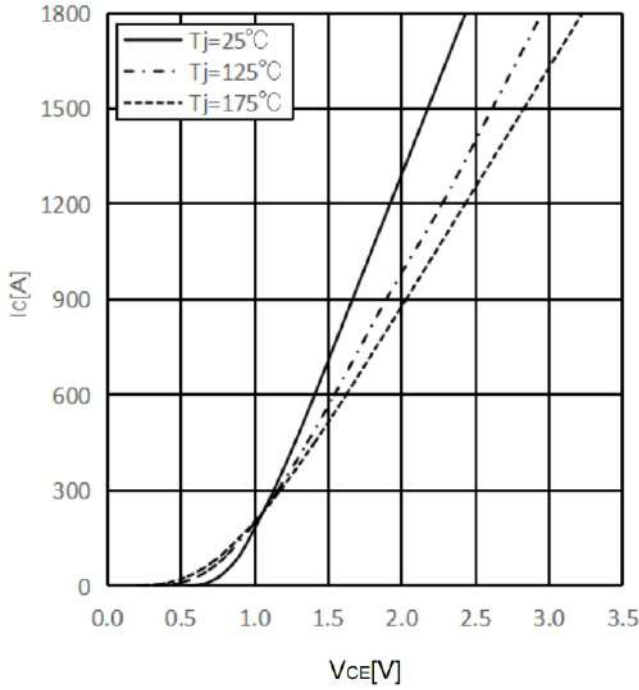
| | | | | | | |
|--|---|----------------------|-----|-------|-----|-----|
| Stray Inductance Module | | L _{sCE} | – | 20 | – | nH |
| Module Lead Resistance, Terminals-Chip | T _C = 25°C, Per Switch | R _{CC'+EE'} | – | 0.8 | – | mΩ |
| Thermal Resistance, Case to Heatsink | including thermal coupling, T _s underneath module (λgrease=0.81 W/(m*K)) | R _{thCH} | – | 0.014 | – | K/W |
| Storage Temperature | | T _{stg} | -40 | – | 125 | °C |
| Mounting Torque for Module Mounting | Screw M5 / M5 | M | 3.0 | – | 6.0 | Nm |
| Power terminal installation torque | Screw M6 / M6 | M | 3.0 | – | 6.0 | Nm |
| Weight | | G | – | 345 | – | g |

1) Terminal impedance is not included.

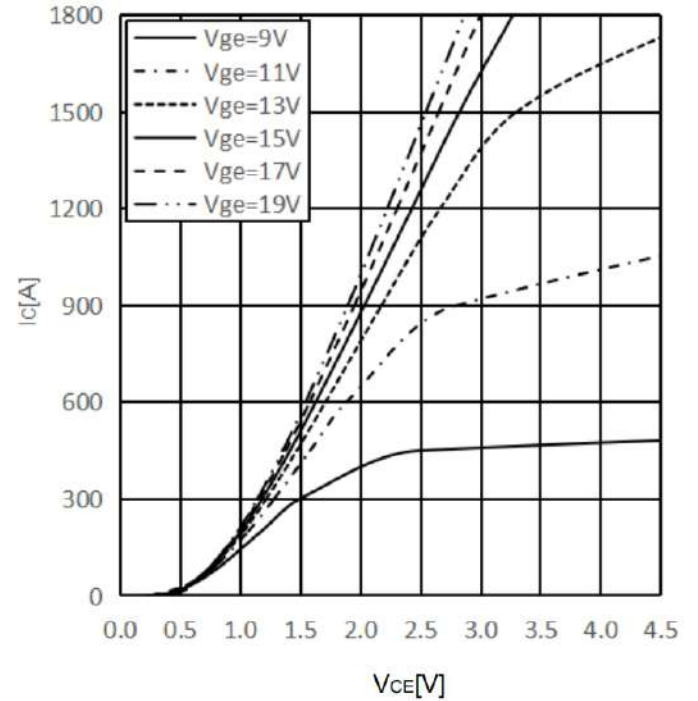
2) CTI is about 200.

Circuit Diagram

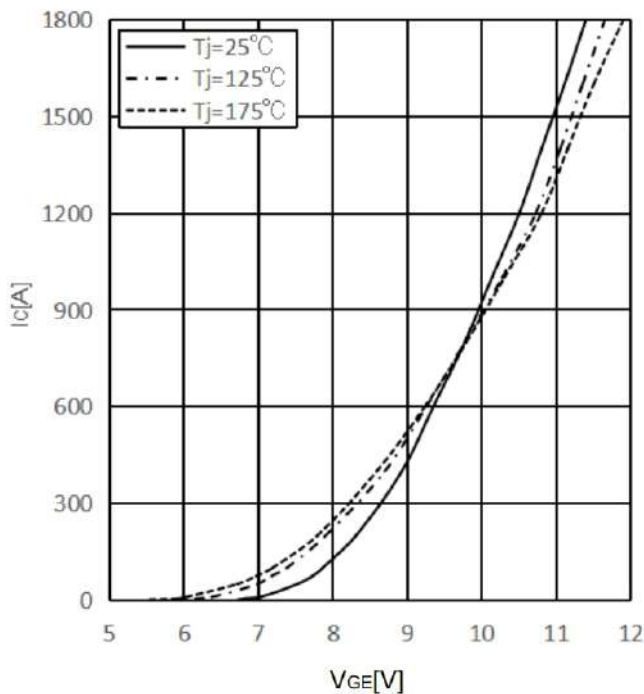
Output characteristic IGBT, Inverter (typical),
Inclusive $R_{CC}+EE'$ $I_c = f(V_{CE}), V_{GE} = 15V$



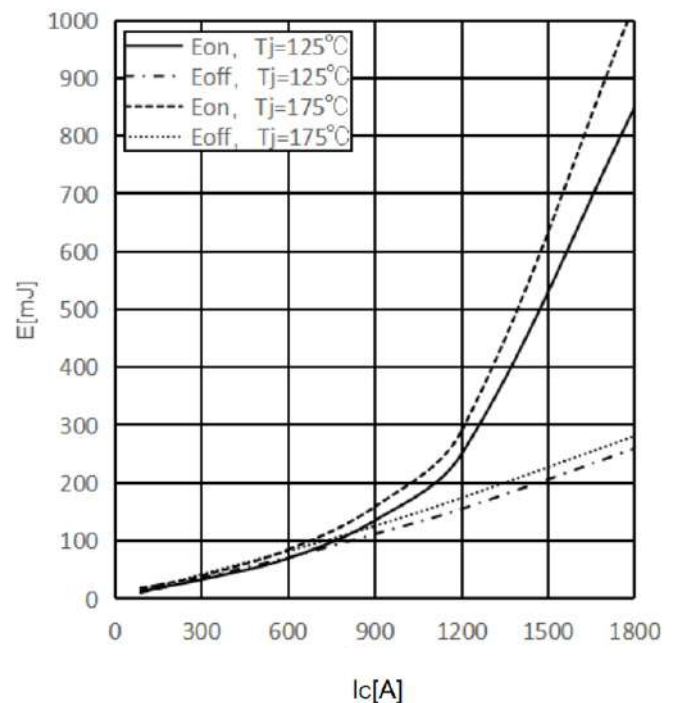
Output characteristic IGBT, Inverter (typical),
Inclusive $R_{CC}+EE'$ $I_c = f(V_{CE}), T_j = 175^\circ C$



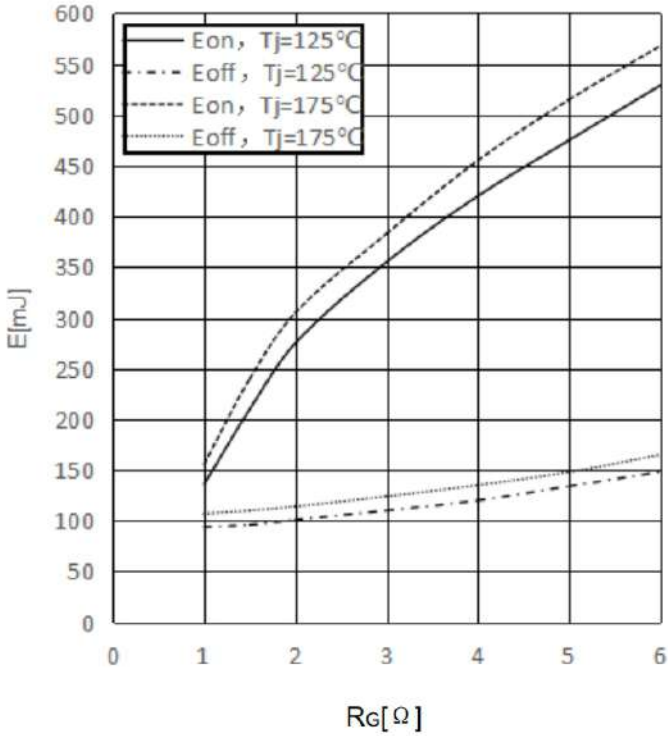
Transfer characteristic IGBT, Inverter (typical),
Inclusive $R_{CC}+EE'$ $I_c = f(V_{GE}), V_{CE} = 20V$



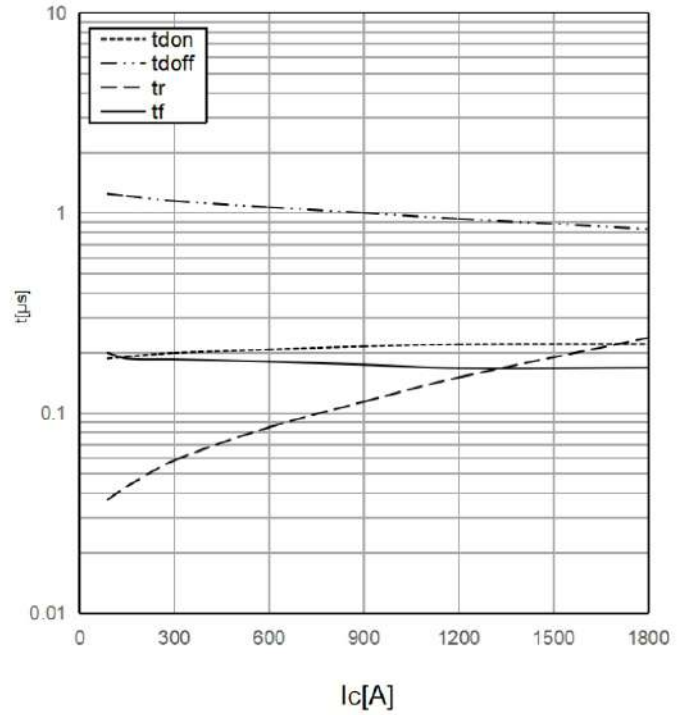
Switching losses IGBT, Inverter (Typical),
Inclusive $R_{CC}+EE'$
 $E = f(I_c), V_{GE} = +15V/-8V, R_{Gon} = 1\Omega,$
 $R_{Goff} = 3\Omega, V_{CC} = 600V$



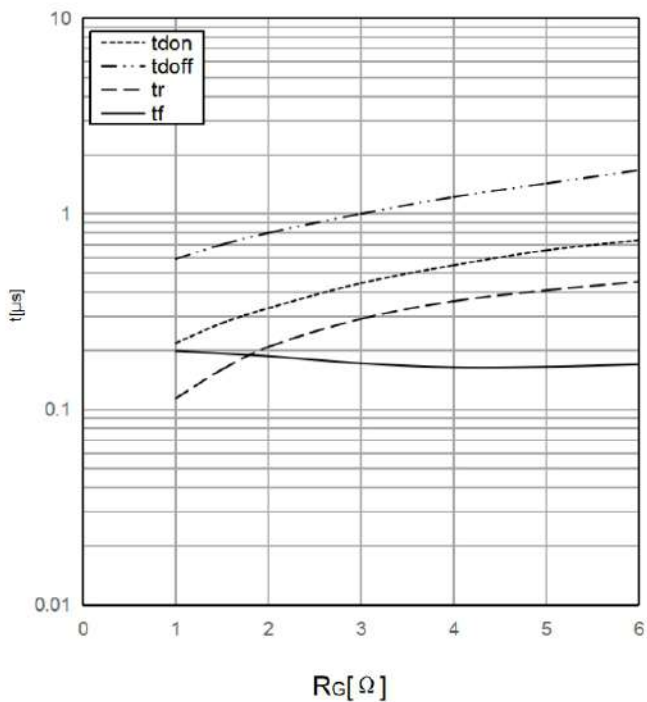
Switching losses IGBT, Inverter (Typical)
 Inclusive $R_{CC} + E_E$
 $E = f(R_G)$, $V_{GE} = +15V/-8V$, $I_C = 900A$, $V_{CE} = 600V$



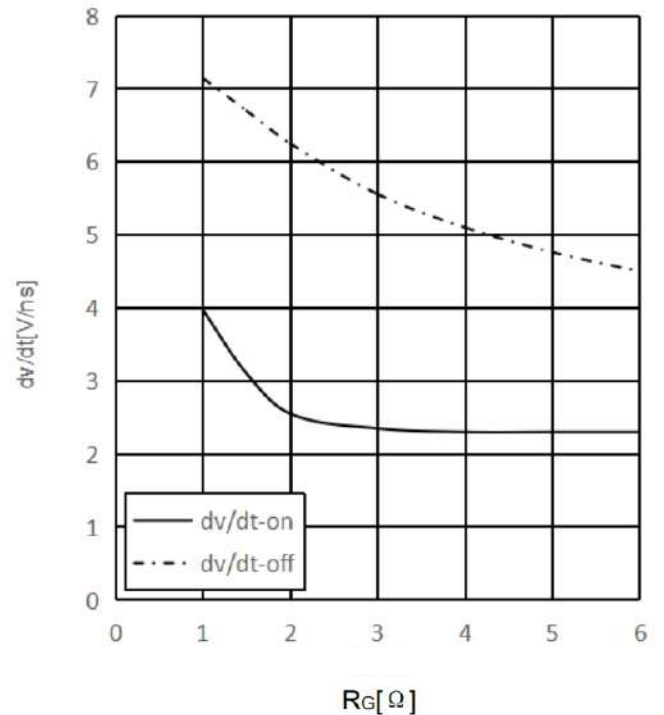
Switching times IGBT, Inverter (Typical)
 $t_{don} = f(I_C)$, $t_r = f(I_C)$, $V_{GE} = +15V/-8V$,
 $R_{Gon} = 1\Omega$, $R_{Goff} = 1\Omega$, $V_{CE} = 600V$, $T_{vj} = 175^\circ C$



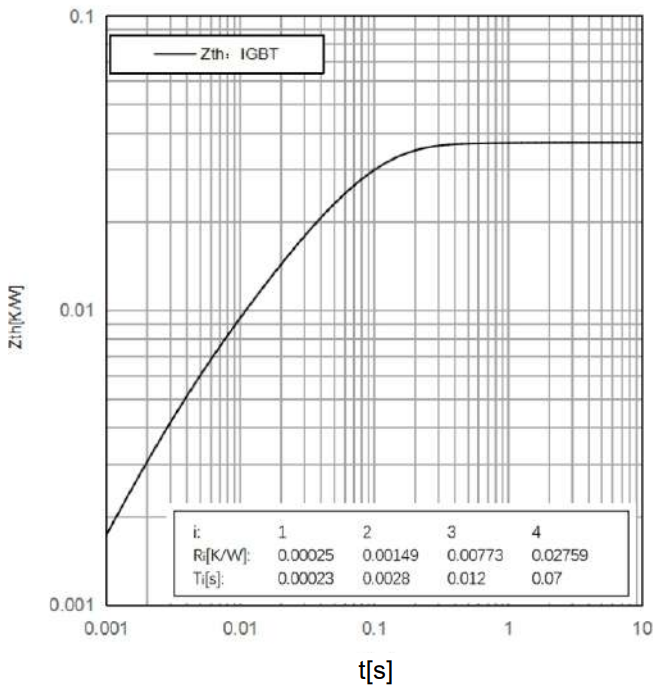
Switching times IGBT, Inverter (Typical)
 $t_{don} = f(R_G)$, $t_r = f(R_G)$, $V_{GE} = +15V/-8V$,
 $I_C = 900A$, $V_{CE} = 600V$, $T_{vj} = 175^\circ C$



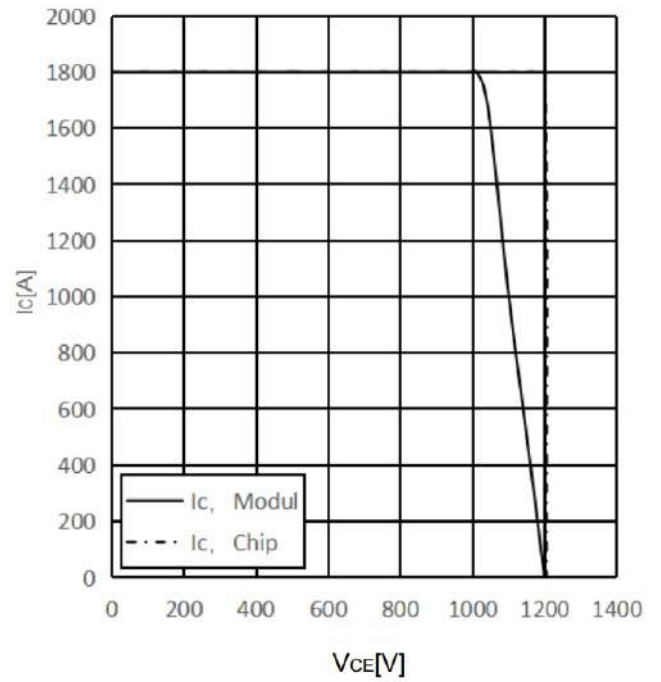
IGBT, Inverter (Typical)
 $dv/dt = f(R_G)$, $V_{GE} = +15V/-8V$,
 $I_C = 900A$, $V_{CE} = 600V$, $T_j = 125^\circ C$



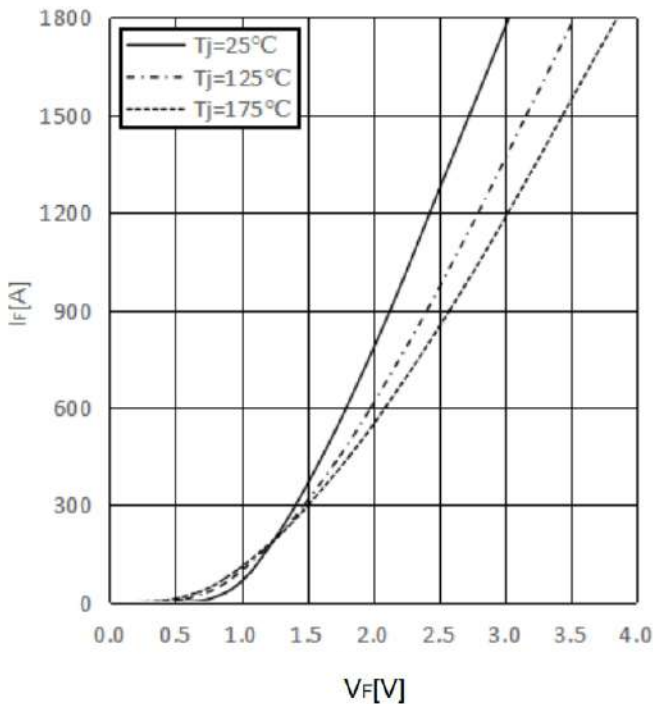
Transient thermal impedance IGBT, Inverter
 $Z_{thJC} = f(t)$



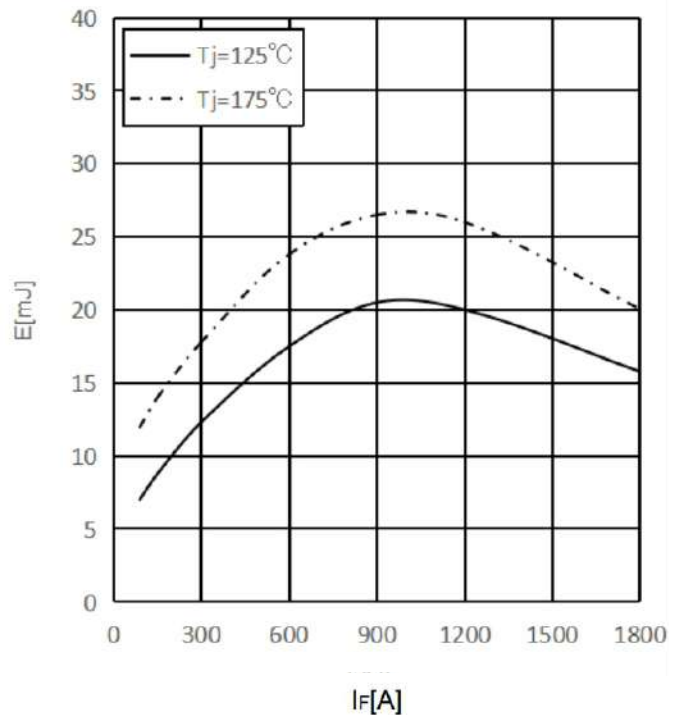
Reverse bias safe operating area IGBT,
 Inverter(RBSOA)
 $I_c = f(V_{CE})$
 $V_{GE} = +15V/-8V, R_{Goff} = 3\Omega, T_j = 175^\circ C$



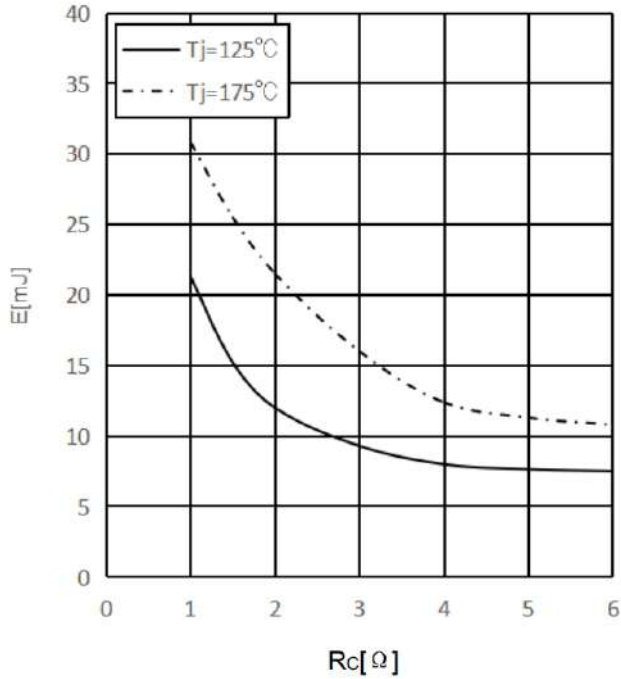
Forward characteristic FRD, Inverter (typical)
 Inclusive RCC+EE'
 $I_F = f(V_F)$



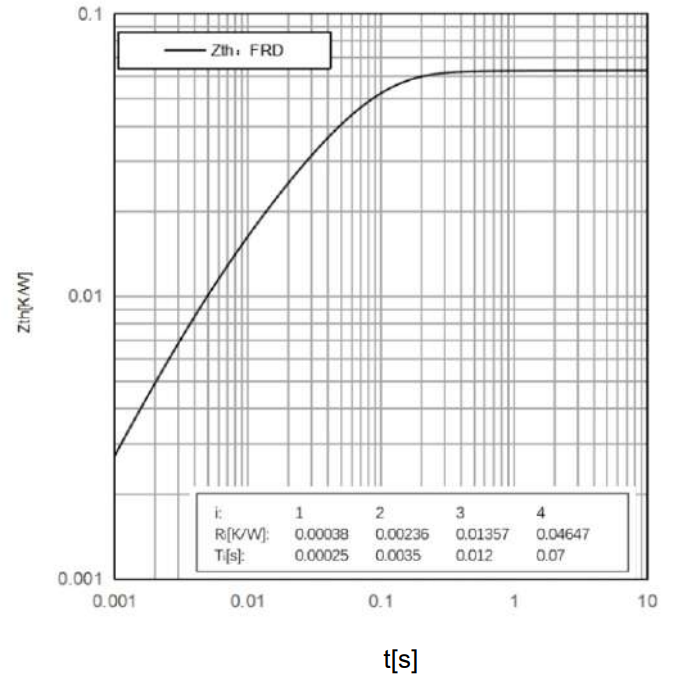
Switching losses FRD, Inverter (typical)
 Inclusive RCC+EE'
 $E_{rec} = f(I_F), R_{Gon} = 1\Omega, V_{CE} = 400V$



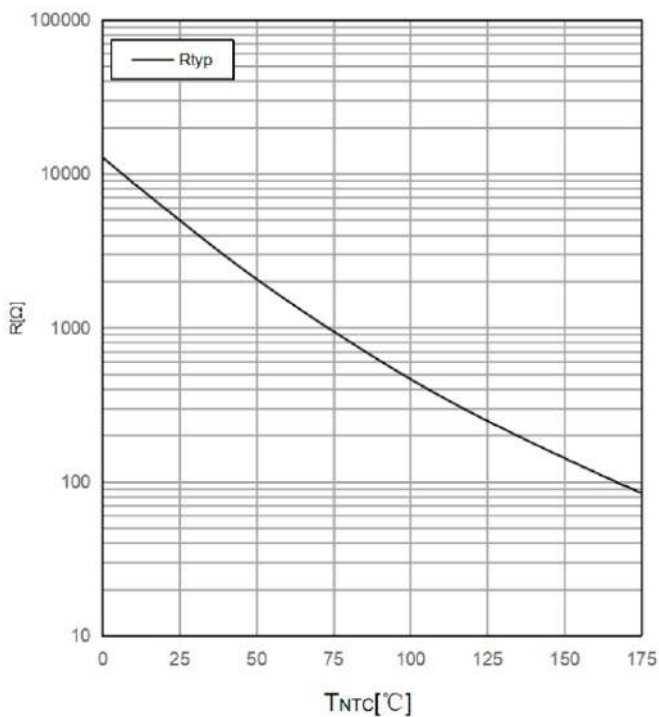
Switching losses FRD, Inverter (typical)
Inclusive $R_{CC}+EE'$
 $E_{rec} = f(R_G)$

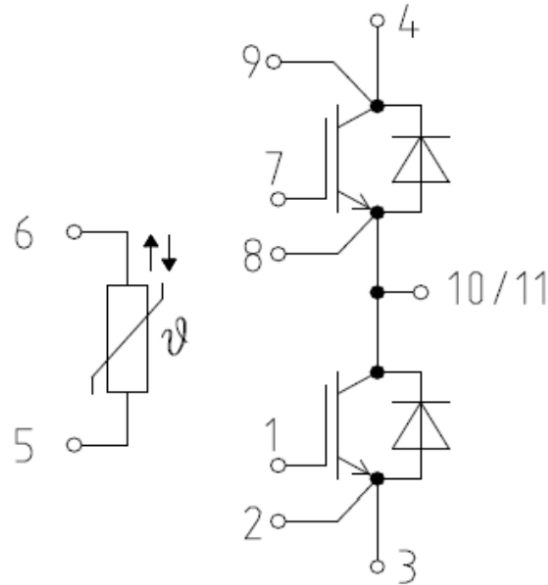
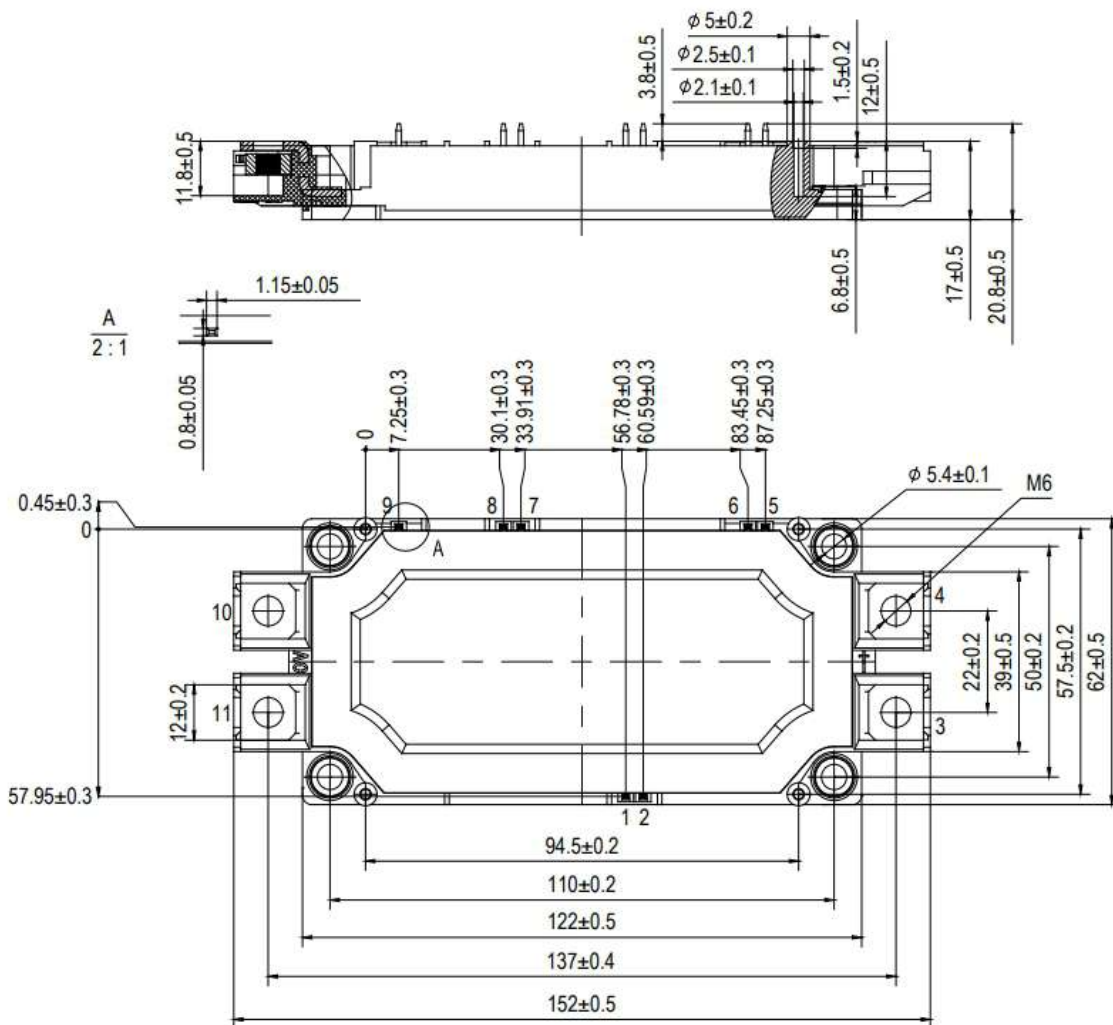


Transient thermal impedance FRD, Inverter
 $Z_{thJC} = f(t)$



NTC Thermistor temperature characteristic (typical)
 $R = f(T)$



Internal Circuit

**Package Dimension
Dimensions in Millimeters**


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